

## APPROVAL SHEET

Approval Specification	Customer's Approval Certificate
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Part No.:	Checked & Approved by:
Customer's Part No.:	Date:

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Part No.	:	SF1399
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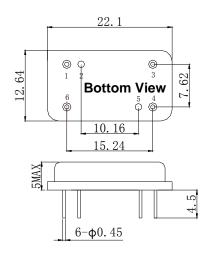
#### **Application**

- Low-loss SAW component
- Low amplitude ripple
- Sharp rejections at both out-bands
- Usable passband 19.4 MHz

#### **Features**

- RoHS compatible
- Package size 22.1x12.64x5.00mm<sup>3</sup>
- Package Code DIP2212J
- Electrostatic Sensitive Device(ESD)

#### Package Dimensions (Unit: mm)





### Pin Configuration

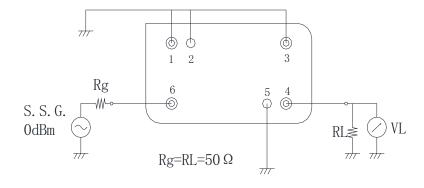
Pin No.	Description
6	Input
4	Output
1,2,3,5	Ground

#### **Marking Description**

S	Trademark	
F	SAW Filter	
1399	Part Number	
•	Pin 1	
YYWW	Year Code & Week Code	

\*Fig: If the products produced in 06<sup>th</sup> week of 2012, The year code & week code is 1206.

#### **Test Circuit(Bottom View)**



Please read notes at the end of this document.

#### **Performance**

#### **Maximum Rating**

Item		Value	Unit
DC Voltage	$V_{DC}$	3	V
Operation Temperature	Т	-40 ~ +85	$^{\circ}$
Storage Temperature	T <sub>stg</sub>	-55 ~ +125	$^{\circ}$
RF Power Dissipation	Р	10	dBm

#### **Electronic Characteristics**

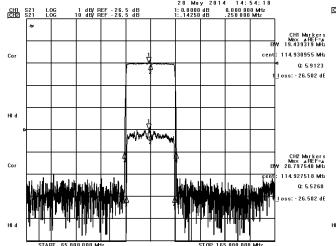
Test Temperature:  $25^{\circ}C \pm 2^{\circ}C$ 

Terminating source impedance:  $50\Omega$  Terminating load impedance:  $50\Omega$ 

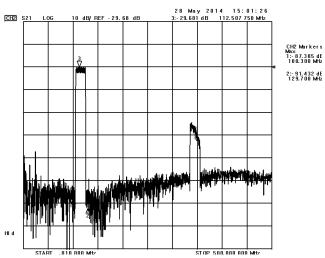
Item			Minimum	Typical	Maximum	Unit
Center Frequency		fc	114.8	115.0	115.2	MHz
Insertion Loss		IL		26.6	27.0	dB
Amplitude Ripple		△a		0.6	1.0	dB
3 dB Bandwidth		BW3dB		19.4		MHz
10 dB Bandwidth		BW <sub>10dB</sub>		20.0	20.1	MHz
40 dB Bandwidth		BW <sub>40dB</sub>		20.8	20.9	MHz
Absolute Delay		AD		2.21		us
Phase Linearity	105.30-124.70MHz			5.5	10.0	deg
Absolute Attenuation		а				
	100.3MHz		50.0	80.0		dB
	129.7MHz		50.0	85.0		dB

#### **Frequency Characteristics**

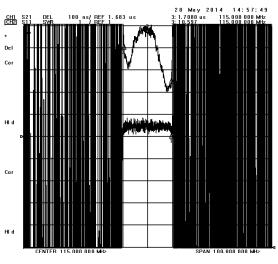
#### Frequency Response



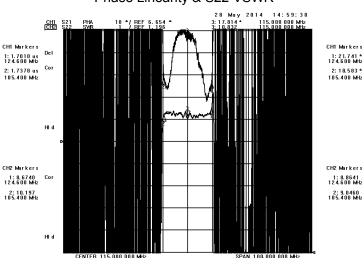
#### Frequency Response (wideband)



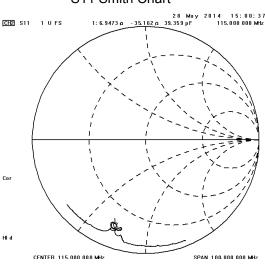
Delay Ripple & S11 VSWR



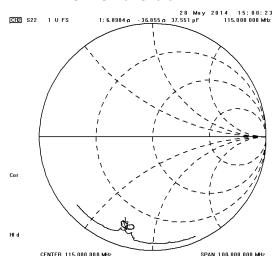
Phase Linearity & S22 VSWR



S11 Smith Chart



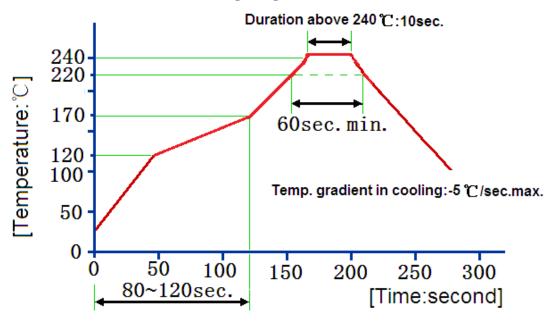
S22 Smith Chart



#### Reliability (The SAW components shall remain electrical performance after tests)

No.	Test item	Test condition			
4	Temperature	(1) Temperature: 85℃±2℃, Duration: 250h, Recovery time: 2h±0.5h			
1	Storage	(2) Temperature: –55°C±3°C , Duration: 250h ,Recovery time: 2h±0.5h			
2	Humidity Test	Conditions: 60℃±2℃, 90~95% RH Duration: 250h			
3	Thermal Shock	Heat cycle conditions: TA=-55℃±3℃, TB=85℃±2℃, t1=t2=30min, Switch			
3	Thermal Shock	time: ≤3min, Cycle time: 100 times, Recovery time: 2h±0.5h.			
4	Vibration Fatigue	Frequency of vibration: 10~55Hz Amplitude:1.5mm			
-	Vibration Latigue	Directions: X,Y and Z Duration: 2h			
5	Drop Test	Cycle time: 10 times Height: 1.0m			
		Temperature: 245 ℃ ±5 ℃ Duration: 3.0s5.0s			
6	Solder Ability Test	Depth: DIP2/3 , SMD1/5			
		(1)Thickness of PCB:1mm , Solder condition: 260 ℃±5 ℃ , Duration: 10±1s			
7	Resistance to Soldering Heat	(2)Temperature of Soldering Iron: 350℃±10℃, Duration: 3~4s,			
		Recovery time: 2 ± 0.5h			

#### **Recommended Reflow Soldering Diagram**



Reflow cycles:3 cycles max.

115.00MHz SAW Filter SF1399 19.40MHz Bandwidth

#### **Notes**

- 1. As a result of the particularity of inner structure of SAW products, it easy to be breakdown by electrostatic, so we should pay attention to **ESD protect** in the test.
- 2. **Static voltage** between signal load and ground may cause deterioration and destruction of the component. Please avoid static voltage.
- 3. **Ultrasonic cleaning** may cause deterioration and destruction of the component. Please avoid ultrasonic cleaning.
- 4. Only leads of component may be soldered. Please avoid soldering another part of component.
- 5. There is a close relationship between the device's performance and **matching network**. The specifications of this device are based on the test circuit shown above. L and C values may change depending on board layout. Values shown are intended as a guide only.

Please read notes at the end of this document.